

GR8 Datasheet

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Revision History

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v0.1	JAT	Sep. 01, 2016	Initial Internal Release
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v1.01	LACG	Aug. 3, 2017	Update UART # in Overview

Declaration

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About This Documentation

From the desk of Gustavo Huber

When Dave, Thomas, and I started Next Thing Co. in 2013, it was with a simple goal: we wanted to create things that would inspire creativity, and help people chase their own ideas of what needed to exist.

We considered this goal both in terms of how economically accessible we could make our products (they had to be \$99 or less), as well as how much “pain” we could remove from the design process for others (they had to be open source and well-documented).

Our first attempt was a software-defined camera named OTTO, built around an off-the-shelf embedded module. But early in development, we knew that our end-goals were at risk. The \$39 module made it impossible to ship product priced under \$99. It lacked Mainline Linux support, a reliable tool-chain, documentation and functional drivers making software development a cat-and-mouse game of bug tracking. But thanks to lots of long days, and some good friends both in Shenzhen and back home in Oakland, we built and shipped out 500 OTTOs -- a serious feat.

Almost exactly a year later, we shipped out the first of what is now over 100,000 C.H.I.P.s delivered worldwide. At \$9, C.H.I.P. was the fruition of our vision from a year prior: accessible, powerful technology, available to everyone for hobby, education, or products. In so many words, we were building the tools that we wished we'd had before.

The reaction was (and continues to be) astounding! Tweets and emails come from far and wide to tell us about impossible projects banged together in an afternoon, classrooms full of proud 10-year-old game developers who had never before written a line of code, and seasoned engineers brought back to memories of discovering their passion on a Commodore 64, 40 years prior. Yet, just as building OTTO showed us the tools we were missing, building C.H.I.P has taught us what it takes to scale production to keep up with [even unprecedented] demand.

So it is with great pleasure that I invite you to explore, without non-disclosure agreements or any other obstructive formalities, this datasheet for GR8: the newest addition to the Next Thing Co. family.

Thanks to the experience and support from our friends at Allwinner and Nanya, GR8 is built from the ground up for clean and reliable design.

With Next Thing Co. and the thriving Chipster community from bbs.nextthing.co at your side, we can't wait to see what you'll do with GR8!

/Gustavo
Co-founder, Hardware Guy

1. Overview

At Next Thing Co., we work to make it easy to integrate computer hardware in products. GR8 provides a powerful application processor and DDR3 SDRAM in a single package, which eliminates the need for high-speed routing and reduces manufacturing complexity. GR8 is a System-in-Package (SiP) that features a 1GHz Allwinner R8 ARMv7 Cortex-A8 processor with NEON SIMD extensions and a Mali-400 GPU. 256MB of Nanya DDR3 SDRAM is combined with the R8 processor into a 14mm x 14mm, 0.8mm pitch 252 ball FBGA package.

In addition to the Mali-400 graphic engine that supports OpenGL ES 1.0 and 2.0. GR8 includes a video engine for encoding and decoding codecs such as VP6/8, AVS, H.264, H.263, MPEG-1/2/4 and a display engine for a hardware cursor, alpha blending, and anti-flicker.

GR8 also features many popular peripheral interfaces: Two-Wire Interface, two UARTs (one 2-wire and one 4-wire), SD Card-ready SPI, two PWM outputs, a 6-bit ADC, I2S digital audio, S/PDIF IEC-60958 digital audio output, two HS/FS/LS USB PHYs (one USB 2.0 Host and one USB 2.0 OTG), a CMOS Sensor Interface.

GR8 is \$6 in any quantity and includes the Allwinner AXP209 power management unit. The minimum order quantity for GR8 + AXP209 is one.

We can't wait to see how you'll design GR8 in to your next product.

1.1. Applications

- Physical Computing
- Voice Recognition
- Smart "Clapper"
- Animated GIF Camera
- Smart Consumer Devices
- Portable Audio Devices
- Cyber Dog Robot Toys

2. Features

2.1. CPU

- ARM Cortex™-A8
- ARMv7 Instruction set plus Thumb-2 Instruction Set
- 32KB Instruction Cache and 32KB Data Cache
- 256KB L2 Cache
- NEON™ SIMD Extensions
- Jazelle RCT Acceleration

2.2. GPU

- Mali400
- Supports Open GL ES 1.1/ 2.0 and Open VG 1.1

2.3. Memory

Boot ROM

- On-chip Boot ROM
- Supports boot from NAND Flash, SPI NOR Flash, SD Card and USB OTG

NANYA DDR3 SDRAM

- In-package 256MB 16-bit DDR3 memory

NAND Flash

- Compliant with ONFI 2.3 and Toggle 1.0
- Up to 8-bit data bus width
- Supports 2 chip selects, and 2 ready/busy signals
- Up to 64-bit ECC per 512 bytes or 1024 bytes
- Supports 1KB/2KB/4KB/8KB/16KB page size
- Supports SLC/MLC NAND and EF-NAND
- Supports SDR/Toggle DDR/ONFI DDR NAND interface

SD/MMC

- Three SD/MMC Host Controllers (SMHC)
- Compatible with eMMC v4.4, SD Physical Layer Specification v2.0, SDIO Card Specification v2.0
- 1-/4-/8-bit bus width
- Supports block size of 1 to 65535 bytes
- Dedicated DMA for fast and uninterrupted data transfer

2.4. System Peripherals

CCM – Clock Control Module

- Seven PLLs driven by a main external Oscillator and an on-chip RC Oscillator
- Supports clock configuration and clock generated for corresponding modules
- Supports software-controlled clock gating and software-controlled reset for corresponding modules

DMA – Direct Memory Access

- Eight channels Normal DMA (NDMA) and eight channels Dedicated DMA (DDMA)
- Supports memory-to-memory, memory-to-peripheral, peripheral-to-memory data transfer types
- Transfer data width of 8/16/32-bit
- Programmable DMA burst size

PWM – Pulse Width Modulation

- Two outputs
- Supports continuous and pulse waveforms
- 0 - 100% adjustable duty cycle
- Up to 24 MHz output frequency

Asynchronous Timer Unit

- Six Asynchronous Timers with interrupt-based operation
- A watchdog timer to generate reset signal or interrupt
- Two 33-bit Audio/Video Sync(AVS) Counter to synchronize video and audio
- One 64-bit Counter

Synchronous Timer Unit

- Two Synchronic Timers with interrupt-based operation

Interrupt Controller

- Normal interrupt requests (nIRQ) and fast interrupt requests (FIQ)
- Supports 96 interrupt sources
- 4-Level priority controller
- External interrupt can be triggered according to edge or level-sensitivity

LRADC– Low Resolution Analog-to-Digital Converter

- Analog to digital converter with 6-bit resolution for key application
- Supports multiple button press detection
- Supports single, normal and continuous work mode
- Sampling frequency up to 250 Hz

Crypto Engine

- Supports AES, DES, 3DES, SHA-1, MD5
- Supports ECB, CBC modes for AES/DES/3DES

- 128 bits, 192 bits and 256 bits key size for AES
- 160-bit hardware Pseudo Random Number Generator (PRNG) with a 175 bit seed

2.5. Video Engine

Video Decoding

- Supports multi-format video decoding of VP6/8, AVS, H.264, H.263, and MPEG-1/2/4
- Up to 1080p@30fps resolution

Video Encoding

- Supports encoding in H.264 MP format
- Up to 720p@30fps resolution

2.6. Display Subsystem

Display Processing

- Four moveable and size-adjustable layers
- Multi-format image input
- Image enhancement processor
- Alpha blending /anti-flicker
- Hardware cursor
- Output color correction (luminance/hue/saturation)

Display Output

- LCD interface (CPU / Sync RGB)
- Supports CVBS output (TV Out)

2.7. Image Input

- Supports 8-bit CMOS sensor interface
- Supports BT656 interface
- Maximum still capture resolution on parallel interface up to 5M
- Maximum video capture resolution on parallel interface up to 1080p@30fps
- Pixel clock up to 150MHz

2.8. Audio Subsystem

Audio Codec - Audio Compression / Decompression Module

- On-chip 24-bit DAC for playback and ADC for recording
- Supports analog/digital volume control
- Supports 44.1 kHz, 48 kHz, 96 kHz, and 192 kHz sample rates
- Stereo microphone input
- Stereo headphone amplifier

I2S/PCM – Inter-IC Sound / Pulse Code Modulation

- Selectable I2S or PCM on shared pins
- Full-duplex synchronous serial interface
- Configurable as a master or a slave
- Audio data resolutions of 16, 20, 24
- I2S Audio data sample rate from 8 kHz to 192 kHz
- Left Justified or Right Justified I2S
- PCM supports 8-bit or 16-bit linear, 8-bit u-law, or 8-bit A-law companding sample format
- One 128x24–bits FIFO for data transmit and one 64x24–bits FIFO for data receive
- Programmable FIFO thresholds

OWA - One Wire Audio

- IEC-60958 transmitter functionality
- Channel status insertion
- Hardware parity generation
- One 32x24bits FIFO (TX) for audio data transfer
- Programmable FIFO thresholds

2.9. External Peripherals

USB – Universal Serial Bus

- One USB 2.0 OTG controller
 - Complies with USB 2.0 Specification
 - Supports High-Speed (HS,480 Mbit/s), Full-Speed (FS,12 Mbit/s) and Low-Speed (LS,1.5 Mbit/s) in host mode
 - Supports High-Speed (HS, 480 Mbit/s), Full-Speed (FS, 12 Mbit/s) in device mode
 - Up to 10 user-configurable endpoints in device mode
- One USB Host controller
 - Complies with Enhanced Host Controller Interface(EHCI)Specification, Version 1.0, and the Open Host Controller Interface(OHCI) Specification, Version 1.0a
 - Supports High-Speed (HS, 480 Mbit/s), Full-Speed (FS, 12 Mbit/s), and Low-Speed (LS, 1.5 Mbit/s) mode

TWI - Two Wire Interface

- Three TWI (Two-Wire Interface) controllers
- Supports Standard mode (up to 100 kbit/s) and Fast mode (up to 400 kbit/s)
- Configurable as a master or a slave
- Capable of 10-bit addressing transactions

UART - Universal Asynchronous Receiver/Transmitter

- Four High-Speed UART controllers
 - UART0 with 2 wires
 - UART1 with 4 wires
 - UART2 with 4 wires
 - UART3 with 4 wires
- Compatible with industry-standard 16550 UARTs
- Support for word length from 5 to 8 bits, an optional parity bit, and 1,1.5 or 2 stop bits
- Programmable parity (even, odd and no parity)

SPI

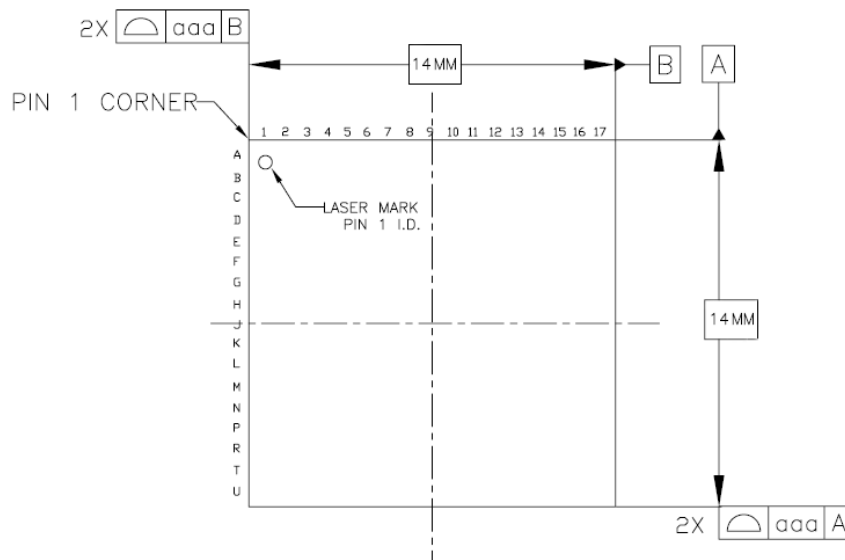
- Two SPI controllers that each have one Chip Select signal
- Full-duplex synchronous serial interface
- Configurable as a master or a slave
- Polarity, phase and clock frequency are configurable

Consumer IR

- One flexible receiver for consumer IR remote control
- Programmable FIFO thresholds

2.10. Package

- FBGA 252 Ball SiP, 14 mm x 14 mm, 0.8 mm pitch



3. Block Diagram

Figure 3.1 shows the block diagram of the GR8.

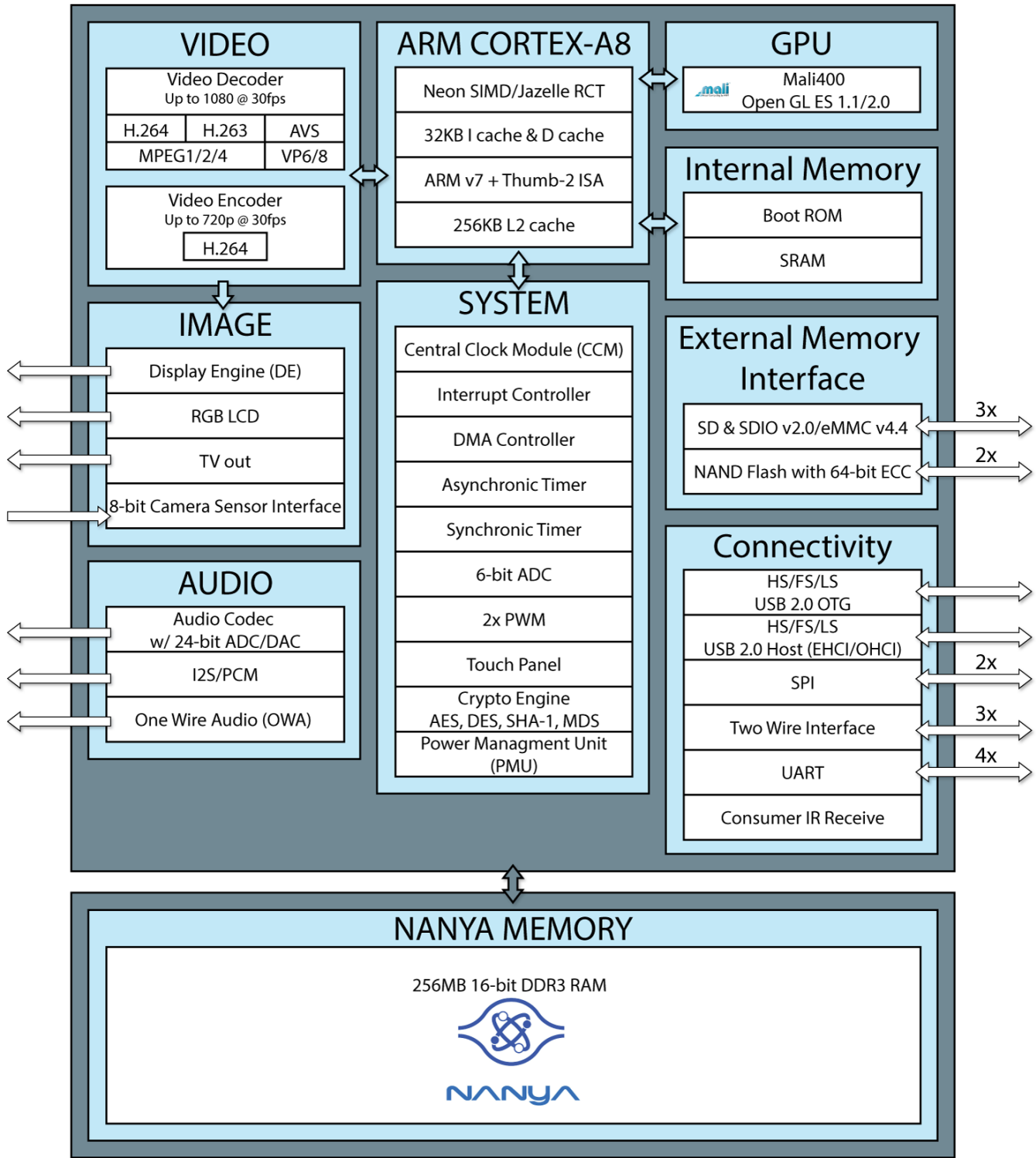


Figure 3.1: GR8 Block Diagram

Figure 3.2 shows the typical application diagram of GR8 processor.

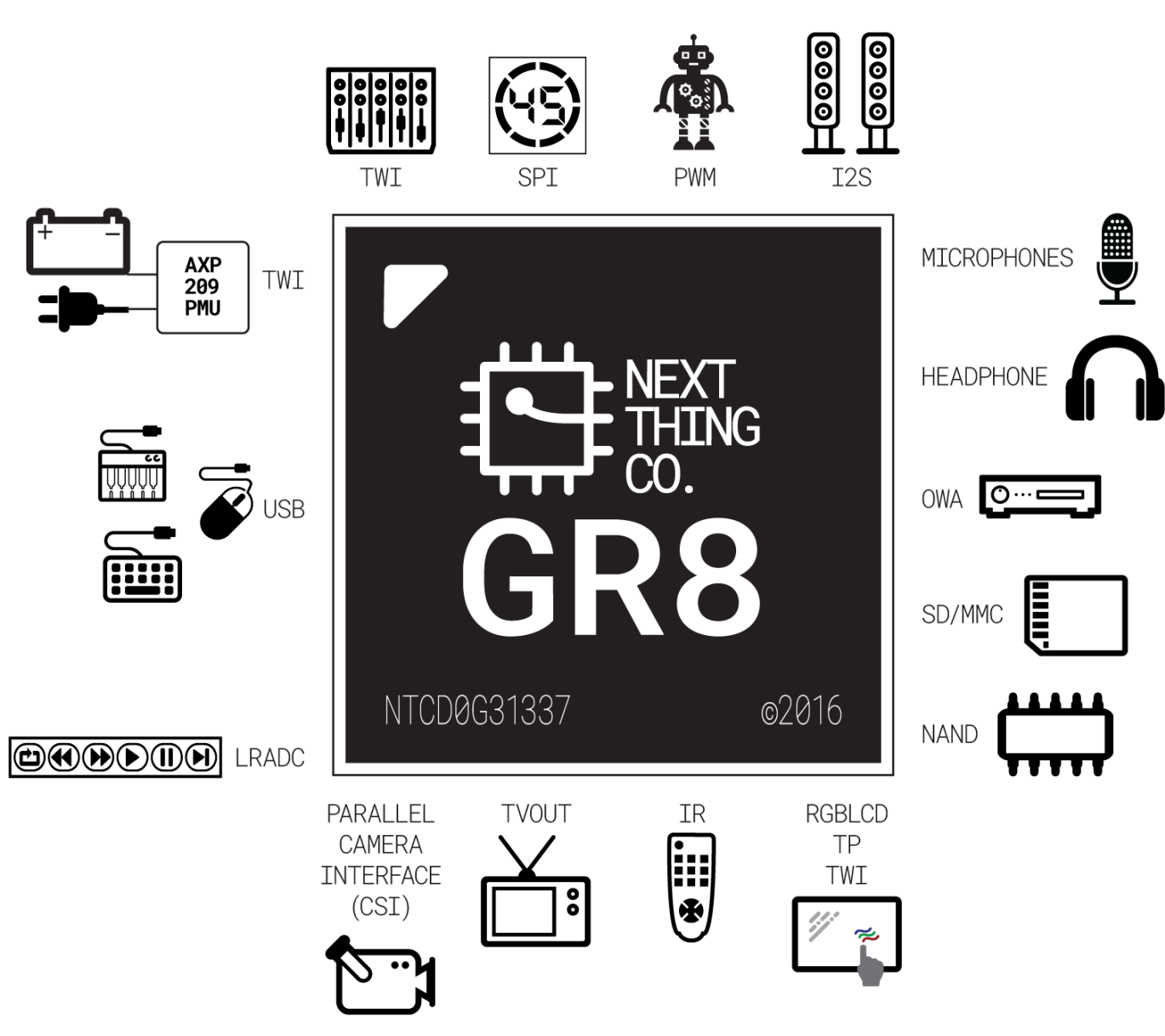


Figure 3.2.: GR8 Typical Application Diagram

4. Pin Description

4.1. Pin Characteristics

Table 4-1 lists the characteristics of GR8's pins including the following aspects: Pin Number, Pin Name, Type, Reset State, Default Pull Up/Down, and Buffer Strength.

- 1) **Pin Number:** Ball numbers on the bottom side associated with each signals on the bottom.
- 2) **Pin Name:** Names of signals multiplexed on each pin No.
- 3) **Type:** Signal direction
 I : Input
 O: Output
 I/O: Input/Output
 A: Analog
 AIO: Analog Input/Output
 OD: Open Drain
 P: Power
 G: Ground
- 4) **Pin Reset State:** The state of the terminal at reset (power up)
 Z: High-impedance
- 5) **Pull Up/Down:** Denotes the presence of an internal pull up or pull down resistor
 Pull up and pull down resistor can be enabled or disabled via software.
- 6) **Buffer Strength:** Drive strength of the associated output buffer.

Table 4.1: Pin Characteristics

Pin Number	Pin Name	Default Function	Type	Reset State	Default Pull Up/Down	Buffer Strength (mA)
SDRAM						
M16	SDZQ1	DRAM	AI	Z	-	-
U11	SZQ	DRAM	AI	Z	-	-
U12	SVREF	DRAM	P	-	-	-
K7,K8,K13,L8, L13,L14,M6, M14	VCC-DRAM	DRAM	P	-	-	-
H8	VDD-DLL	DRAM	P	-	-	-
PORT B						
B11	PB0	GPIO	I/O	Z	NO PULL	20
A11	PB1	GPIO	I/O	Z	NO PULL	20
C12	PB2	GPIO	I/O	Z	NO PULL	20
H4	PB3	GPIO	I/O	Z	NO PULL	20
A12	PB4	GPIO	I/O	Z	NO PULL	20
T6	PB5	GPIO	I/O	Z	NO PULL	20
U7	PB6	GPIO	I/O	Z	NO PULL	20
U8	PB7	GPIO	I/O	Z	NO PULL	20

Pin Number	Pin Name	Default Function	Type	Reset State	Default Pull Up/Down	Buffer Strength (mA)
T7	PB8	GPIO	I/O	Z	NO PULL	20
T9	PB9	GPIO	I/O	Z	NO PULL	20
T8	PB10	GPIO	I/O	Z	NO PULL	20
P4	PB11	GPIO	I/O	Z	NO PULL	20
N4	PB12	GPIO	I/O	Z	NO PULL	20
P5	PB13	GPIO	I/O	Z	NO PULL	20
N5	PB14	GPIO	I/O	Z	NO PULL	20
B10	PB15	GPIO	I/O	Z	NO PULL	20
C10	PB16	GPIO	I/O	Z	NO PULL	20
T5	PB17	GPIO	I/O	Z	NO PULL	20
U5	PB18	GPIO	I/O	Z	NO PULL	20
PORT C						
R6	PC0	GPIO	I/O	Z	NO PULL	20
R7	PC1	GPIO	I/O	Z	NO PULL	20
R5	PC2	GPIO	I/O	Z	NO PULL	20
M3	PC3	GPIO	I/O	Z	PULL UP	20
T4	PC4	GPIO	I/O	Z	PULL UP	20
R4	PC5	GPIO	I/O	Z	NO PULL	20
U3	PC6	GPIO	I/O	Z	PULL UP	20
T3	PC7	GPIO	I/O	Z	PULL UP	20
U2	PC8	GPIO	I/O	Z	NO PULL	20
R2	PC9	GPIO	I/O	Z	NO PULL	20
T2	PC10	GPIO	I/O	Z	NO PULL	20
T1	PC11	GPIO	I/O	Z	NO PULL	20
N2	PC12	GPIO	I/O	Z	NO PULL	20
R1	PC13	GPIO	I/O	Z	NO PULL	20
P1	PC14	GPIO	I/O	Z	NO PULL	20
P2	PC15	GPIO	I/O	Z	NO PULL	20
P3	PC19	GPIO	I/O	Z	NO PULL	20
PORT D						
F1	PD2	GPIO	I/O	Z	NO PULL	20
L2	PD3	GPIO	I/O	Z	NO PULL	20
E1	PD4	GPIO	I/O	Z	NO PULL	20
F2	PD5	GPIO	I/O	Z	NO PULL	20
E2	PD6	GPIO	I/O	Z	NO PULL	20
E4	PD7	GPIO	I/O	Z	NO PULL	20
F4	PD10	GPIO	I/O	Z	NO PULL	20

Pin Number	Pin Name	Default Function	Type	Reset State	Default Pull Up/Down	Buffer Strength (mA)
J2	PD11	GPIO	I/O	Z	NO PULL	20
G2	PD12	GPIO	I/O	Z	NO PULL	20
K2	PD13	GPIO	I/O	Z	NO PULL	20
E3	PD14	GPIO	I/O	Z	NO PULL	20
D2	PD15	GPIO	I/O	Z	NO PULL	20
F3	PD18	GPIO	I/O	Z	NO PULL	20
G4	PD19	GPIO	I/O	Z	NO PULL	20
D3	PD20	GPIO	I/O	Z	NO PULL	20
C1	PD21	GPIO	I/O	Z	NO PULL	20
C2	PD22	GPIO	I/O	Z	NO PULL	20
B1	PD23	GPIO	I/O	Z	NO PULL	20
C3	PD24	GPIO	I/O	Z	NO PULL	20
B3	PD25	GPIO	I/O	Z	NO PULL	20
C4	PD26	GPIO	I/O	Z	NO PULL	20
B2	PD27	GPIO	I/O	Z	NO PULL	20
PORT E						
A8	PE0	GPIO	I/O	Z	NO PULL	20
B7	PE1	GPIO	I/O	Z	NO PULL	20
A6	PE2	GPIO	I/O	Z	NO PULL	20
B5	PE3	GPIO	I/O	Z	NO PULL	20
A5	PE4	GPIO	I/O	Z	NO PULL	20
B6	PE5	GPIO	I/O	Z	NO PULL	20
B4	PE6	GPIO	I/O	Z	NO PULL	20
C7	PE7	GPIO	I/O	Z	NO PULL	20
A3	PE8	GPIO	I/O	Z	NO PULL	20
D5	PE9	GPIO	I/O	Z	NO PULL	20
A2	PE10	GPIO	I/O	Z	NO PULL	20
C5	PE11	GPIO	I/O	Z	NO PULL	20
PORT F						
D8	PF0	GPIO	I/O	Z	NO PULL	20
B8	PF1	GPIO	I/O	Z	NO PULL	20
A9	PF2	GPIO	I/O	Z	NO PULL	20
C11	PF3	GPIO	I/O	Z	NO PULL	20
B8	PF4	GPIO	I/O	Z	NO PULL	20
D10	PF5	GPIO	I/O	Z	NO PULL	20
PORT G						
N3	PG0	GPIO	I/O	Z	NO PULL	20

Pin Number	Pin Name	Default Function	Type	Reset State	Default Pull Up/Down	Buffer Strength (mA)
H2	PG1	GPIO	I/O	Z	NO PULL	20
M1	PG2	GPIO	I/O	Z	NO PULL	20
J1	PG3	GPIO	I/O	Z	NO PULL	20
H1	PG4	GPIO	I/O	Z	NO PULL	20
F5	PG5	GPIO	I/O	Z	NO PULL	20
J3	PG6	GPIO	I/O	Z	NO PULL	20
H3	PG7	GPIO	I/O	Z	NO PULL	20
L1	PG8	GPIO	I/O	Z	NO PULL	20
R9	PG9	GPIO	I/O	Z	NO PULL	20
P7	PG10	GPIO	I/O	Z	NO PULL	20
U10	PG11	GPIO	I/O	Z	NO PULL	20
R8	PG12	GPIO	I/O	Z	NO PULL	20
T10	PG13	GPIO	I/O	Z	NO PULL	20
System						
K3	UBOOT	-	I	-	PULL UP	-
C6	JTAG-SEL1	-	I	-	PULL UP	-
M2	NMI	-	I/O	-	-	-
L3	RESET	-	I	-	-	-
Main Clock						
A16	X24MIN	-	AI	-	-	-
B16	X24MOUT	-	AO	-	-	-
TVOUT						
C8	TVOUT	-	AO	-	-	-
USB						
B14	USB0-DM	-	A I/O	-	-	-
A14	USB0-DP	-	A I/O	-	-	-
B13	USB1-DM	-	A I/O	-	-	-
A13	USB1-DP	-	A I/O	-	-	-
D7	VCC-USB	-	P	-	-	-
TP						
B15	TPX1	-	AI	-	-	-
C15	TPY1	-	AI	-	-	-
C17	TPX2	-	AI	-	-	-
B17	TPY2	-	AI	-	-	-
Audio Codec						
F16	AGND	-	G	-	-	-
F12	AVCC	-	P	-	-	-

Pin Number	Pin Name	Default Function	Type	Reset State	Default Pull Up/Down	Buffer Strength (mA)
G15	HPBP	-	AO	-	-	-
G17	HPCOM	-	AO	-	-	-
H17	HPCOMFB	-	AI	-	-	-
F15	HPL	-	AO	-	-	-
F17	HPR	-	AO	-	-	-
E16	LINEINL	-	AI	-	-	-
E15	LINEINR	-	AI	-	-	-
D14	MIC1OUTN	-	AO	-	-	-
D15	MIC1OUTP	-	AO	-	-	-
D17	MICIN1	-	AI	-	-	-
D16	MICIN2	-	AI	-	-	-
G16	VCC-HP	-	P	-	-	-
E14	VMIC	-	AO	-	-	-
E12	VRA1	-	AO	-	-	-
E13	VRA2	-	AO	-	-	-
F13	VRP	-	AO	-	-	-
LRADC						
C13	LRADC0	-	AI	-	-	-
D13	LRADC1	-	AI	-	-	-
Power						
J4,K4,K6,L4,L5, L6,M5	VDD-CPU	-	P	-	-	-
D6,H5,M4	VCC-IO	-	P	-	-	-
D4,E5,J8	VDD-SYS	-	P	-	-	-
GND						
A1,A15,A17,B12,C14, C16,C9,D11,D9,E10, E6,E7,E8,E9,F10,F14, F6,F7,F8,F9,G10,G14, G3,G5,G6,G7,G8,G9, H10,H12,H16,H6,H7, H9,J10,J11,J17,J5,J6, K15,K17,K5,L10,L11, L12,L9,M10,M11, M12,M13,M15,M17, M7,M8,M9,N10,N11, N12,N13,N14,N15, N16,N17,N6,N7,N8, N9,P10,P11,P12,P13, P14,P15,P16,P17,P6, P8,P9,R10,R11,R12, R13,R14,R15,R16, R17,R3,T11,T12,T13, T14,T15,T16,T17,U1, U13,U14,U15,U16,	GND	-	G	-	-	-



Pin Description

Pin Number	Pin Name	Default Function	Type	Reset State	Default Pull Up/Down	Buffer Strength (mA)
U17,U9						

4.2. GPIO Multiplexing Functions

The following table provides a description of the GR8 GPIO multiplexing functions.

Table 4.2: Multiplexing Functions

Port	Multi0	Multi1	Multi2	Multi3	Multi4	Multi5	Multi6
PORT B							
PB0	Input	Output	TWI0-SCK				
PB1	Input	Output	TWI0-SDA				
PB2	Input	Output	PWM0				EINT16
PB3	Input	Output					EINT17
PB4	Input	Output	IR-RX				EINT18
PB5	Input	Output	I2S-MCLK				EINT19
PB6	Input	Output	I2S-BCLK				EINT20
PB7	Input	Output	I2S-LRCK				EINT21
PB8	Input	Output	I2S-DO				EINT22
PB9	Input	Output	I2S-DI				EINT23
PB10	Input	Output		OWA-DO			EINT24
PB11	Input	Output	SPI2-CS0	JTAG-MS0			EINT25
PB12	Input	Output	SPI2-CLK	JTAG-CK0			EINT26
PB13	Input	Output	SPI2-MOSI	JTAG-DO0			EINT27
PB14	Input	Output	SPI2-MISO	JTAG-DI0			EINT28
PB15	Input	Output	TWI1-SCK				
PB16	Input	Output	TWI1-SDA				
PB17	Input	Output	TWI2-SCK				
PB18	Input	Output	TWI2-SDA				
PORT C							
PC0	Input	Output	NWE	SPI0-MOSI			
PC1	Input	Output	NALE	SPI0-MISO			
PC2	Input	Output	NCLE	SPI0-CLK			
PC3	Input	Output	NCE1	SPI0-CS0			
PC4	Input	Output	NCE0				
PC5	Input	Output	NRE				
PC6	Input	Output	NRB0	SDC2-CMD			
PC7	Input	Output	NRB1	SDC2-CLK			
PC8	Input	Output	NDQ0	SDC2-D0			
PC9	Input	Output	NDQ1	SDC2-D1			
PC10	Input	Output	NDQ2	SDC2-D2			

PC11	Input	Output	NDQ3	SDC2-D3			
PC12	Input	Output	NDQ4	SDC2-D4			
PC13	Input	Output	NDQ5	SDC2-D5			
PC14	Input	Output	NDQ6	SDC2-D6			
PC15	Input	Output	NDQ7	SDC2-D7			
PC19	Input	Output	NDQS				
Port D							
PD2	Input	Output	LCD-D2	UART2-TX			
PD3	Input	Output	LCD-D3	UART2-RX			
PD4	Input	Output	LCD-D4	UART2-CTS			
PD5	Input	Output	LCD-D5	UART2-RTS			
PD6	Input	Output	LCD-D6				
PD7	Input	Output	LCD-D7				
PD10	Input	Output	LCD-D10				
PD11	Input	Output	LCD-D11				
PD12	Input	Output	LCD-D12				
PD13	Input	Output	LCD-D13				
PD14	Input	Output	LCD-D14				
PD15	Input	Output	LCD-D15				
PD18	Input	Output	LCD-D18				
PD19	Input	Output	LCD-D19				
PD20	Input	Output	LCD-D20				
PD21	Input	Output	LCD-D21				
PD22	Input	Output	LCD-D22				
PD23	Input	Output	LCD-D23				
PD24	Input	Output	LCD-CLK				
PD25	Input	Output	LCD-DE				
PD26	Input	Output	LCD-HSYNC				
PD27	Input	Output	LCD-VSYNC				
Port E							
PE0	Input			CSI-PCLK	SPI2-CS0		EINT14
PE1	Input			CSI-MCLK	SPI2-CLK		EINT15
PE2	Input			CSI-HSYNC	SPI2-MOSI		
PE3	Input	Output		CSI-VSYNC	SPI2-MISO		
PE4	Input	Output		CSI-D0	SDC2-D0		
PE5	Input	Output		CSI-D1	SDC2-D1		
PE6	Input	Output		CSI-D2	SDC2-D2		
PE7	Input	Output		CSI-D3	SDC2-D3		
PE8	Input	Output		CSI-D4	SDC2-CMD		
PE9	Input	Output		CSI-D5	SDC2-CLK		

PE10	Input	Output		CSI-D6	UART1-TX		
PE11	Input	Output		CSI-D7	UART1-RX		
Port F							
PF0	Input	Output	SDC0-D1		JTAG-MS1		
PF1	Input	Output	SDC0-D0		JTAG-DI1		
PF2	Input	Output	SDC0-CLK		UART0-TX		
PF3	Input	Output	SDC0-CMD		JTAG-DO1		
PF4	Input	Output	SDC0-D3		UART0-RX		
PF5	Input	Output	SDC0-D2		JTAG-CK1		
Port G							
PG0	Input						EINT0
PG1	Input						EINT1
PG2	Input						EINT2
PG3	Input	Output	SDC1-CMD		UART1-TX		EINT3
PG4	Input	Output	SDC1-CLK		UART1-RX		EINT4
PG5	Input	Output	SDC1-D0		UART1-CTS		EINT5
PG6	Input	Output	SDC1-D1		UART1-RTS		EINT6
PG7	Input	Output	SDC1-D2				EINT7
PG8	Input	Output	SDC1-D3				EINT8
PG9	Input	Output	SPI1_CS0	UART3-TX			EINT9
PG10	Input	Output	SPI1_CLK	UART3-RX			EINT10
PG11	Input	Output	SPI1_MOSI	UART3-CTS			EINT11
PG12	Input	Output	SPI1_MISO	UART3-RTS			EINT12
PG13	Input	Output		PWM1			EINT13

Note: PE0/PE1/PE2/PG0/PG1/PG2 are for input only.

4.3. Detailed Pin/Signal Description

Table 4-3 shows the detailed function of every pin/signal based on the different interface.

Table 4.3: Detailed Pin/Signal Description

Pin/Signal Name	Description	Type
TWI		
TWI0-SCK	TWI0 Clock	I/O
TWI0-SDA	TWI0 Data/Address	I/O
TWI1-SCK	TWI1 Clock	I/O
TWI1-SDA	TWI1 Data/Address	I/O
TWI2-SCK	TWI2 Clock	I/O

Pin/Signal Name	Description	Type
TWI2-SDA	TWI2 Data/Address	I/O
PWM		
PWM0	Pulse Width Module Channel0 Output	O
PWM1	Pulse Width Module Channel1 Output	O
IR		
IR-RX	Consumer Infra-Red Data Receive	I
I2S		
I2S-MCLK	I2S Master Clock	O
I2S-BCLK	I2S Bit Clock	I/O
I2S-LRCK	I2S Left/Right Channel Select Clock	I/O
I2S-DO	I2S Data Output	O
I2S-DI	I2S Data Input	I
OWA – One Wire Audio		
OWA-DO	OWA Data Output	O
SPI – Serial Peripheral Interface		
SPI0-CS0	SPI0 Chip Select Signal(active low)	I/O
SPI0-CLK	SPI0 Clock Signal	I/O
SPI0-MISO	SPI0 Master Data In, Slave Data Out	I/O
SPI0-MOSI	SPI0 Master Data Out, Slave Data In	I/O
SPI1-CS0	SPI1 Chip Select Signal(active low)	I/O
SPI1-CLK	SPI1 Clock Signal	I/O
SPI1-MISO	SPI1 Master Data In, Slave Data Out	I/O
SPI1-MOSI	SPI1 Master Data Out, Slave Data In	I/O
UART – Universal Asynchronous Receiver/Transmitter		
UART0-TX	UART0 Data Transmit	O
UART0-RX	UART0 Data Receive	I
UART1-TX	UART1 Data Transmit	O
UART1-RX	UART1 Data Receive	I
UART1-CTS	UART1 Data Clear to Send	I
UART1-RTS	UART1 Data Request to Send	O
UART2-TX	UART2 Data Transmit	O
UART2-RX	UART2 Data Receive	I
UART2-CTS	UART2 Data Clear to Send	I
UART2-RTS	UART2 Data Request to Send	O
UART3-TX	UART3 Data Transmit	O
UART3-RX	UART3 Data Receive	I
UART3-CTS	UART3 Data Clear to Send	I
UART3-RTS	UART3 Data Request to Send	O
JTAG – Debug / Test		

Pin/Signal Name	Description	Type
JTAG-DO[1:0]	JTAG Data Output	O
JTAG-DI[1:0]	JTAG Data Input	I
JTAG-MS[1:0]	JTAG Mode Select Input	I
JTAG-CK[1:0]	JTAG Clock Input	I
NAND Flash		
NWE	NAND Flash Write Enable	O
NALE	NAND Flash Address Latch Enable	O
NCLE	NAND Flash Command Latch Enable	O
NCE[1:0]	NAND Flash Chip Select	O
NRE	NAND Flash Read Enable	O
NRB[1:0]	NAND Flash Ready/Busy Status Indicator Signal	I
NDQ[7:0]	NAND Flash Data Bit	I/O
NDQS	NAND Flash Data Strobe	I/O
LCD		
LCD-D[7:2]	LCD Data Bit[7:2]	O
LCD-D[15:10]	LCD Data Bit[15:10]	O
LCD-D[23:18]	LCD Data Bit[23:18]	O
LCD-CLK	LCD Clock Signal	O
LCD-DE	LCD Data Enable	O
LCD-HSYNC	LCD Horizontal Sync	O
LCD-VSYNC	LCD Vertical Sync	O
CSI – Camera Sensor Interface		
CSI-PCLK	CSI Pixel Clock	I
CSI-MCLK	CSI Master Clock	O
CSI-HSYNC	CSI Horizontal Sync	I
CSI-VSYNC	CSI Vertical Sync	I
CSI-Data[7:0]	CSI Data Bit	I
SD/MMC		
SDC0-D[3:0]	SDC0 Data Bit[3:0]	I/O
SDC0-CLK	SDC0 Clock	O
SDC0-CMD	SDC0 Command Signal	I/O
SDC1-D[3:0]	SDC1 Data Bit[3:0]	I/O
SDC1-CLK	SDC1 Clock	O
SDC1-CMD	SDC1 Command Signal	I/O
SDC2-D[7:0]	SDC2 Data Bit[7:0]	I/O
SDC2-CLK	SDC2 Clock	O
SDC2-CMD	SDC2 Command Signal	I/O
External Interrupt		
EINT[28:0]	External Interrupt Input	I

Pin/Signal Name	Description	Type
System		
UBOOT	Boot Mode Select	I
JTAG-SEL1	JTAG Mode Select	I
NMI	Non-Maskable Interrupt	I/O
RESET	Reset Signal	I
Clock		
X24MIN	Clock Input of 24MHz Crystal	AI
X24MOUT	Clock Output of 24MHz Crystal	AO
TV-OUT		
TV-OUT	TV Output	AO
USB		
USB0-DM	USB0 D- Signal	A I/O
USB0-DP	USB0 D+ Signal	A I/O
USB1-DM	USB1 D- Signal	A I/O
USB1-DP	USB1 D+ Signal	A I/O
VCC-USB	USB Power Supply	P
Touch Panel		
TPX1	Touch Panel X1 Input	AI
TPY1	Touch Panel Y1 Input	AI
TPX2	Touch Panel X2 Input	AI
TPY2	Touch Panel Y2 Input	AI
Audio Codec		
AGND	Audio Codec Analog Ground	G
AVCC	Audio Codec Power Supply	P
HPBP	Headphone Bypass Output	AO
HPCOM	Headphone Common Reference Output	AO
HPCOMFB	Headphone Common Reference Feedback Input	AI
HPL	Headphone Left Channel Output	AO
HPR	Headphone Right Channel Output	AO
LINEINL	Line In Left Channel Input	AI
LINEINR	Line In Right Channel Input	AI
MIC1OUTN	Microphone Negative Output	AO
MIC1OUTP	Microphone Positive Output	AO
MICIN1	Microphone Input	AI
MICIN2	Microphone Input	AI
VCC-HP	Headphone Power Supply	P
VMIC	Bias Voltage Output for Main Microphone	AO
VRA1	Reference Voltage Output	AO
VRA2	Reference Voltage Output	AO



Pin Description

Pin/Signal Name	Description	Type
VRP	Reference Voltage Output	AO
LRADC		
LRADC0	ADC Input Channel0 for Key	AI
LRADC1	ADC Input Channel1 for Key	AI

5. Electrical Characteristics

5.1. Absolute Maximum Ratings

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Table 5-1 specifies the absolute maximum ratings over the operating junction temperature range of commercial and extended temperature devices. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this standard may damage to the device.

Table 5.1: Absolute Maximum Ratings

Symbol	Parameter	Min	Max	Unit	
$I_{I/O}$	In/Out Current for Input and Output	-40	40	mA	
VCC-IO	Supply Voltage for I/O	-0.3	3.6	V	
VDD-SYS	Supply Voltage for System	-0.3	1.5	V	
VDD-DLL	Supply Voltage for DRAM DLL	-0.3	1.5	V	
VDD-CPU	Supply Voltage for CPU	-0.3	1.5	V	
AVCC	Supply Voltage for Analog Part	-0.3	3.6	V	
VCC-DRAM	Supply Voltage for DRAM	-0.3	1.98	V	
VCC-USB	Supply Voltage for USB	-0.3	3.6	V	
VCC-HP	Supply Voltage for Headphone	-0.3	3.6	V	
T_{STG}	Storage Temperature	-40	125	°C	
V_{ESD}	Electrostatic Discharge	Human Body Model(HBM) ⁽¹⁾	-4000	4000	V
		Charged Device Model(CDM) ⁽²⁾	-500	500	V
$I_{Latch-up}$	Latch-up I-test performance current-pulse injection on each IO pin ⁽³⁾	Pass			
	Latch-up over-voltage performance voltage injection on each IO pin ⁽⁴⁾	Pass			

- 1). Test method: JEDEC JS-001-2014(Class-3A). JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.
- 2). Test method: JEDEC JS-002-2014(Class-C2A). JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.
- 3). Current test performance: Pins stressed per JEDEC JESD78D (Class I, Level A) and passed with I/O pin injection current as defined in JEDEC.
- 4). Over voltage performance: Supplies stressed per JEDEC JESD78D (Class I, Level A) and passed voltage injection as defined in JEDEC.

5.2. Recommended Operating Conditions

All GR8 modules are used under the operating conditions contained in Table 5.2.

Table 5.2: Recommended Operating Conditions

Symbol	Parameter	Min	Typ	Max	Unit
T_a	Ambient Operating Temperature	-20	-	+70	°C
VCC-IO	Supply Voltage for I/O	1.7	1.8~3.3	3.6	V
VDD-SYS	Supply Voltage for System	1.1	1.2	1.3	V
VDD-DLL	Supply Voltage for DRAM DLL	1.1	1.2	1.3	V

VDD-CPU	Supply Voltage for CPU	1.1	1.2	1.4	V
AVCC	Supply Voltage for Analog Part	-	3.0	-	V
VCC-DRAM	Supply Voltage for DRAM	1.425	1.5	1.575	V
VCC-USB	Supply Voltage for USB	3.0	3.3	3.6	V
VCC-HP	Supply Voltage for Headphone	3.0	-	3.3	V

5.3. DC Electrical Characteristics

Table 5.3 summarizes the DC electrical characteristics of GR8.

Table 5.3: DC Electrical Characteristics

Symbol	Parameter	Min	Typ	Max	Unit
V _{IH}	High-Level Input Voltage	0.7 * VCC-IO	-	VCC-IO + 0.3	V
V _{IL}	Low-Level Input Voltage	-0.3	-	0.3 * VCC-IO	V
R _{PU}	Input Pull-up Resistance	50	100	150	KΩ
R _{PD}	Input Pull-down Resistance	50	100	150	KΩ
I _{IH}	High-Level Input Current	-	-	10	uA
I _{IL}	Low-Level Input Current	-	-	10	uA
V _{OH}	High-Level Output Voltage	VCC-IO -0.2	-	VCC-IO	V
V _{OL}	Low-Level Output Voltage	0	-	0.2	V
I _{OZ}	Tri-State Output Leakage Current	-10	-	10	uA
C _{IN}	Input Capacitance	-	-	5	pF
C _{OUT}	Output Capacitance	-	-	5	pF

5.4. Oscillator Electrical Characteristics

GR8 contains one 24.000MHz oscillator.

The 24.000MHz frequency is used to generate the main source clock for PLL and the main digital blocks, the clock is provided through X24MIN. Table 5-4 lists the 24.000MHz crystal specifications.

Table 5.4: 24MHz Crystal Characteristics

Symbol	Parameter	Min	Typ	Max	Unit
1/(t _{CPMAIN})	Crystal Oscillator Frequency Range	-	24.000	-	MHz
t _{ST}	Startup Time	-	-	-	ms
	Frequency Tolerance at 25 °C	-50	-	+50	ppm
	Oscillation Mode	Fundamental			-
	Maximum Change Over Temperature Range	-50	-	+50	ppm
P _{ON}	Drive Level	-	-	300	uW
C _L	Equivalent Load Capacitance	12	18	22	pF
R _S	Series Resistance(ESR)	-	25	-	Ω
	Duty Cycle	30	50	70	%

C _M	Motional Capacitance	-	-	-	pF
C _{SHUT}	Shunt Capacitance	5	6.5	7.5	pF
R _{BIAS}	Internal Bias Resistor	0.4	0.5	0.6	MΩ

5.5. Power Up/Down and Reset Specifications

The section provides information about the GR8 power up and power down sequence requirements.

5.5.1. Power Up Sequence Requirements

These requirements must be applied to meet the GR8 device power-up requirements (system power off to power on).

- Power up all domains simultaneously.
- The RESET pin must be held on low until all power domains are stable.

Figure 5-1 shows the power up sequence.

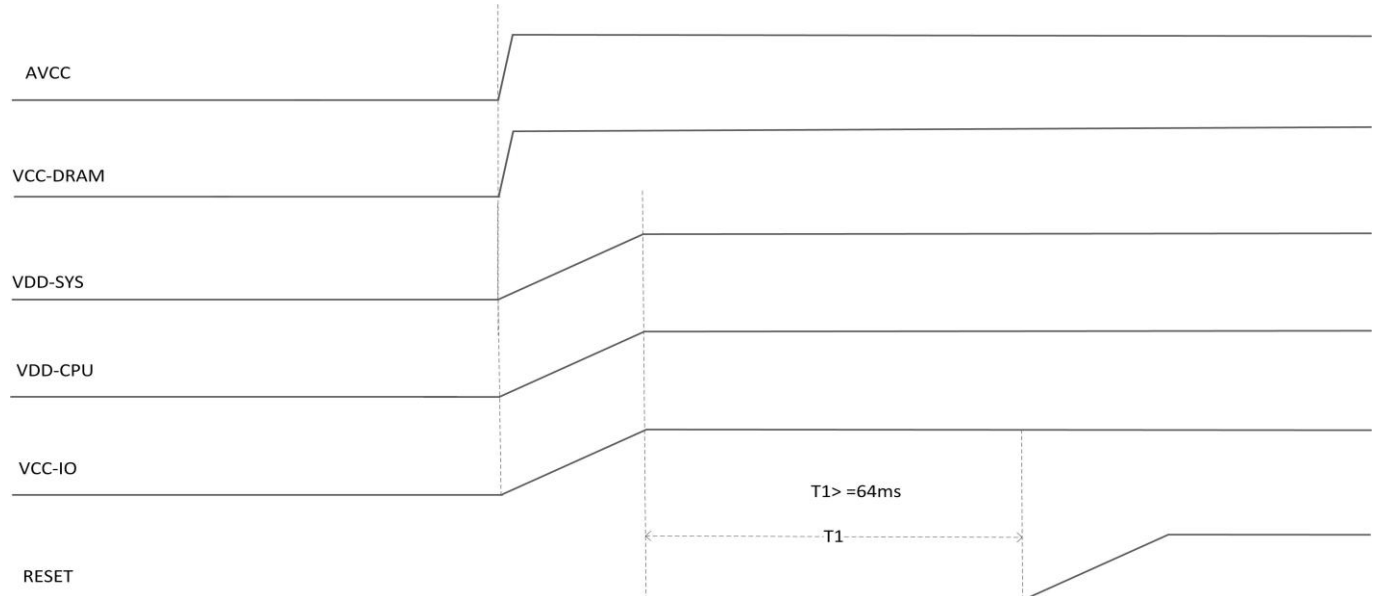


Figure 5.1: Power Up Sequence

5.5.2. Power Up Reset Sequence Requirements

The device has a system reset signal to reset the board. When asserted, the following steps give an example of power up reset sequence supported by the GR8 device.

- AVCC, VDD-CPU and VCC-DRAM can be powered up simultaneously.
- VDD-SYS can be powered up after VDD-CPU is powered up, the time difference is T2 ms.
- VCC-IO can be powered up after VDD-SYS is powered up, the time difference is T3 ms.
- The RESET pin must be held on low until all power domains are stable.

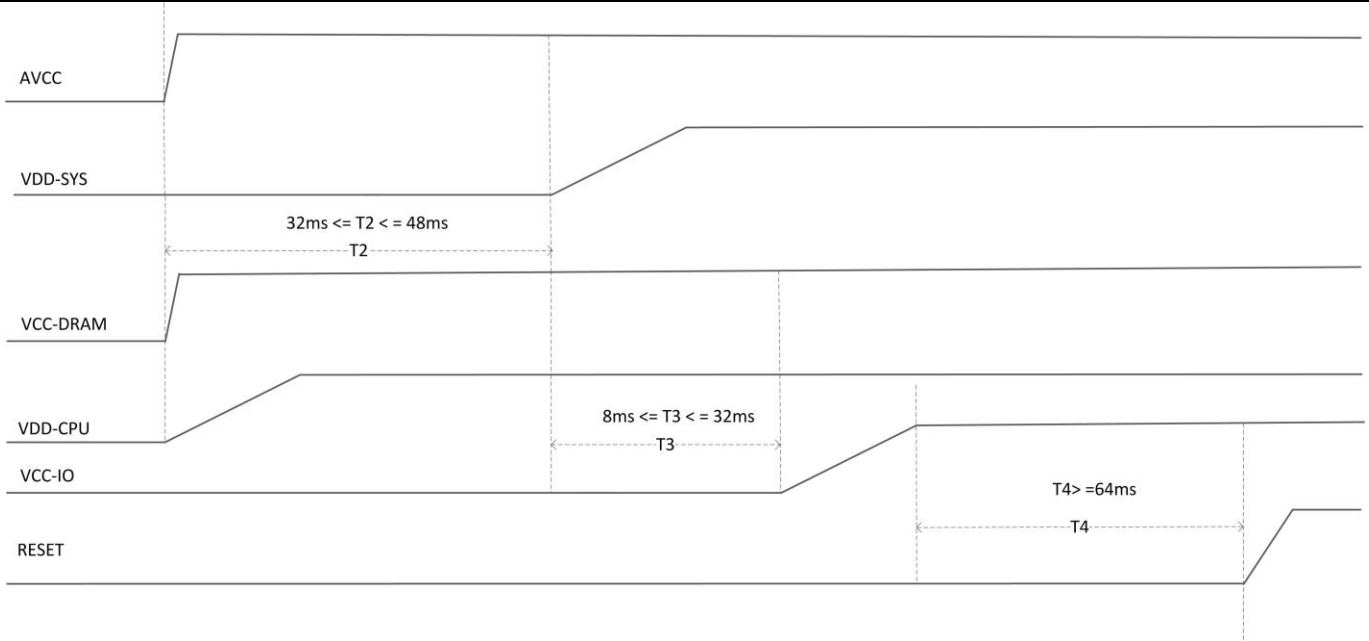


Figure 5.2: Power Up Reset Sequence

5.5.3. Resume Power Up Sequence from Super Standby Mode

To resume a power up sequence when the device is in Super Standby mode:

- VCC-DRAM and AVCC remains powered up always.
- VDD-CPU can be powered up firstly.
- VDD-SYS can be powered up after VDD-CPU is powered up, the time difference is T_5 ms.
- VCC-IO can be powered up after VDD-SYS is powered up, the time difference is T_6 ms.
- The RESET pin must be held on low until all power domains are stable.

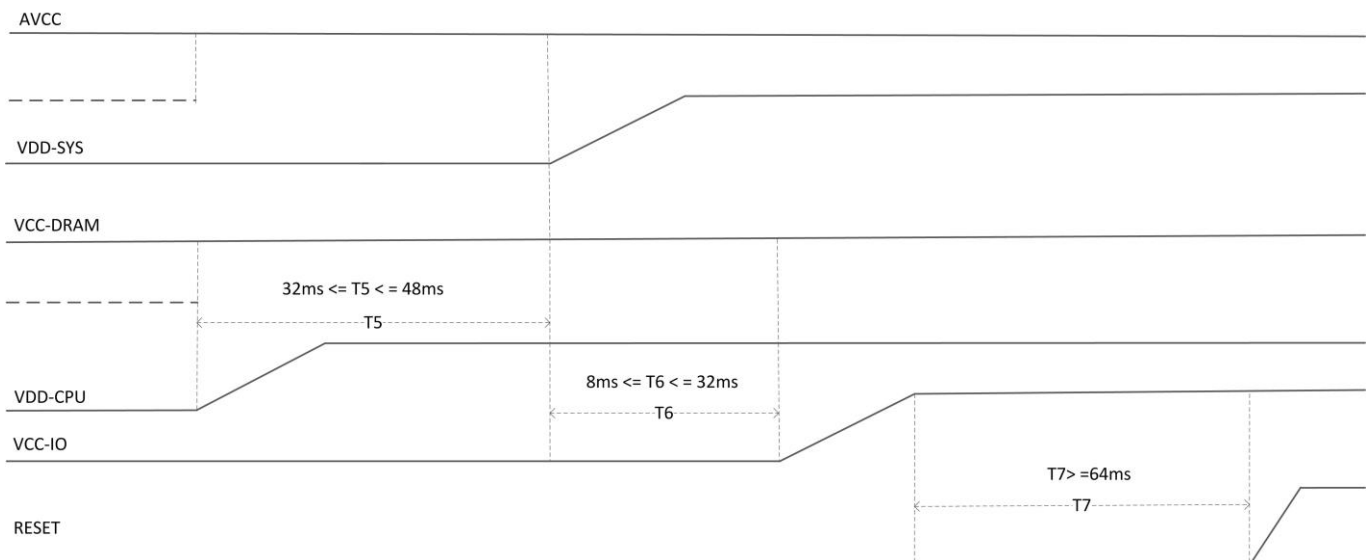


Figure 5.3: Exit Super Standby and Resume Power Up Sequence

5.5.4. Power Down Sequence Requirements

To reduce power consumption, the GR8 can be partially powered down. The section lists the power down requirements in each mode. In Super Standby mode,

- VCC-DRAM and AVCC must be kept powered up.
- VDD-CPU, VDD-SYS and VCC-IO are powered down simultaneously.
- The falling time of VCC-IO is longest. The ramping down rate is decided by the load on the power supply.

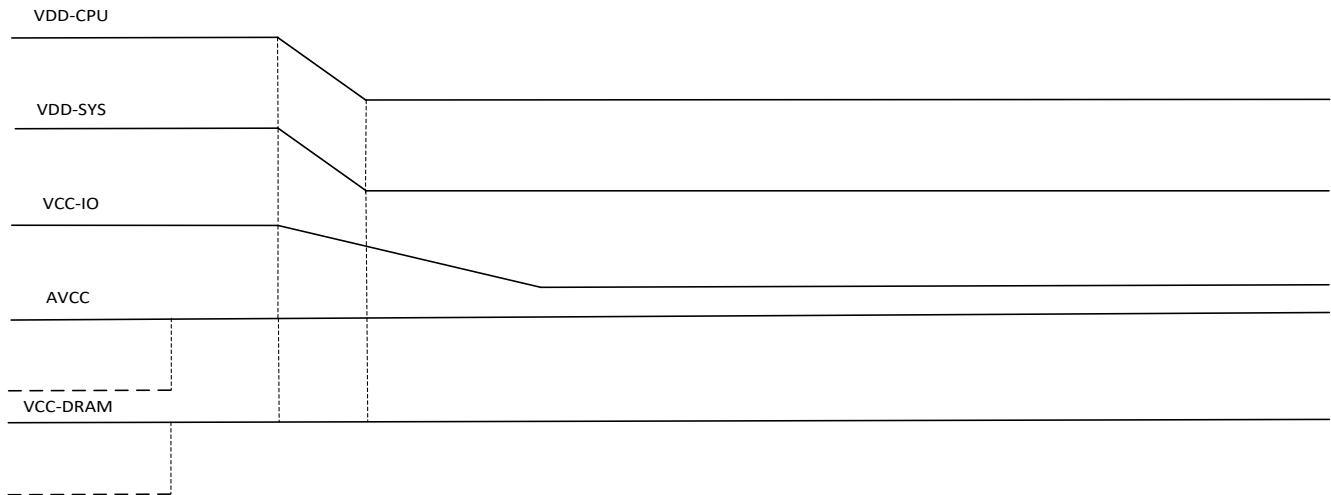


Figure 5.4: Power Down and Enter Super Standby Sequence

Figure 5-5 gives an example of the power-down sequence supported by the GR8 device.

- VDD-CPU, VDD-SYS and VCC-IO are powered down simultaneously.
- VCC-DRAM and AVCC can be powered down after delay 16ms.
- The falling time of VCC-IO is longest. The ramping down rate is decided by the load on the power supply.

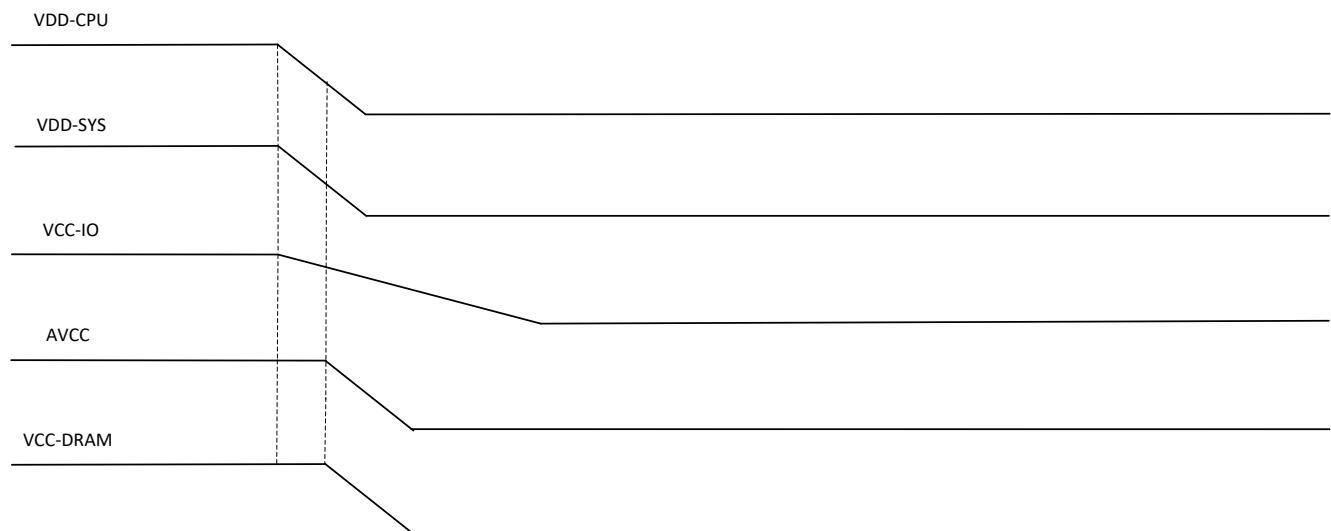


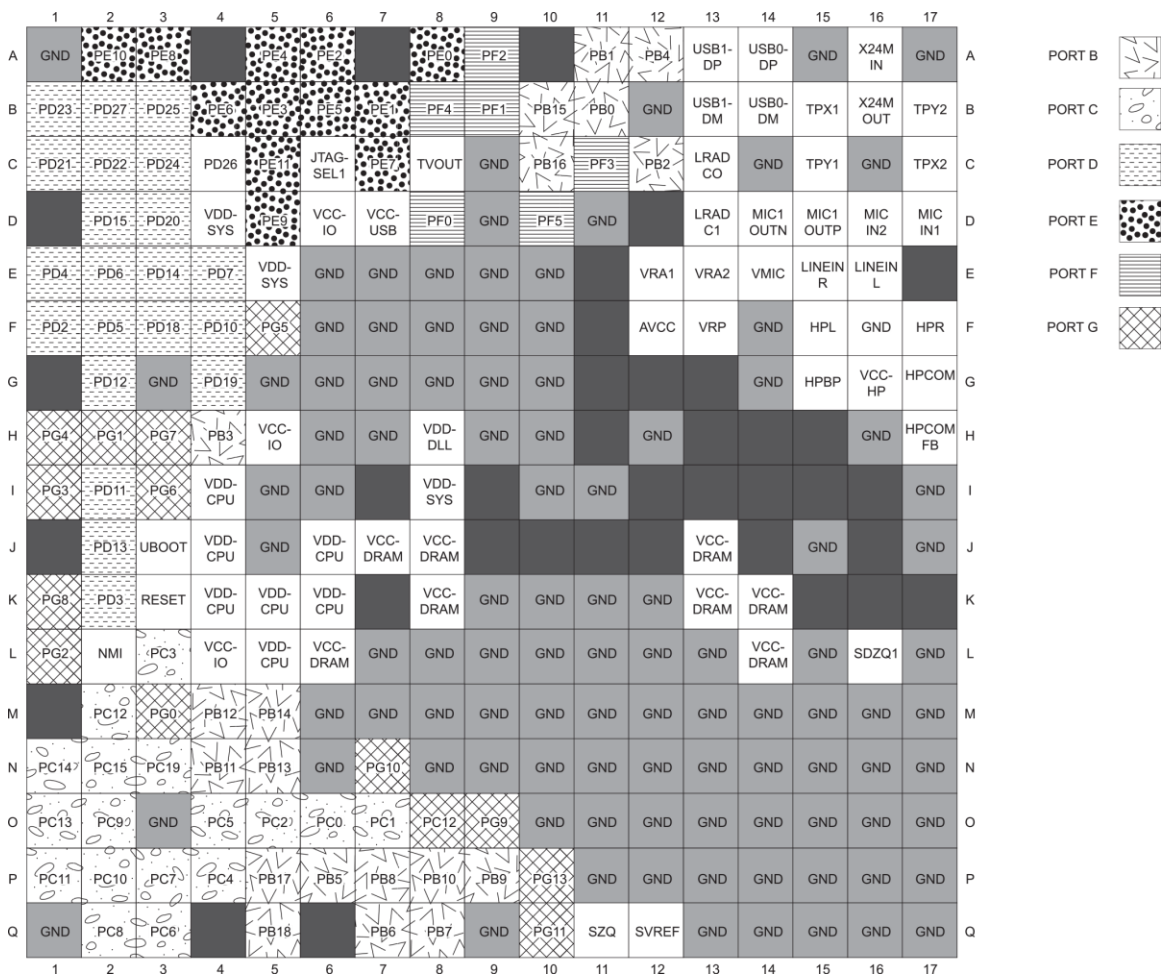
Figure 5.5: Power Down Sequence

6. Pin Assignment

6.1. Pin Map

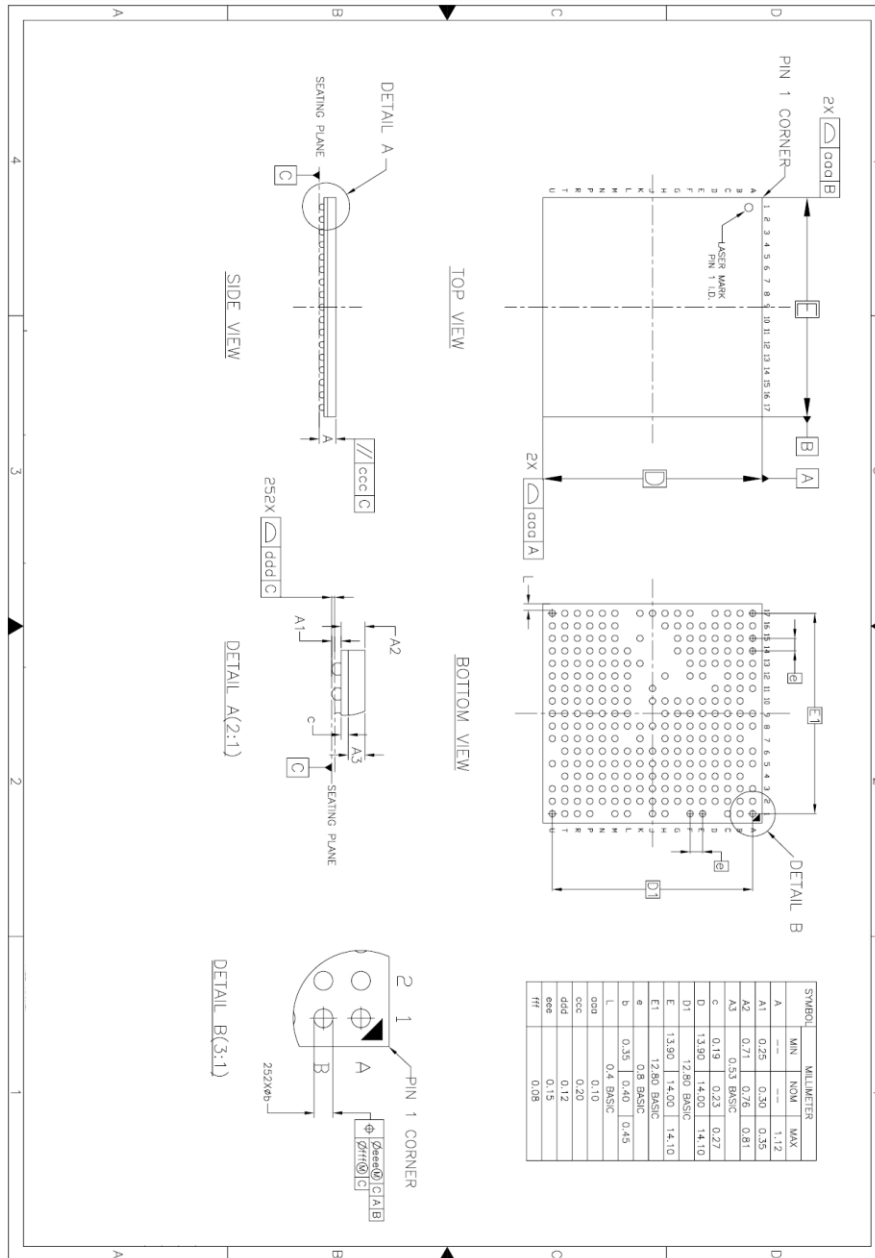
The following pin map is a top view of the GR8's 252-pin FBGA package. Patterns in the map below indicate the I/O ports grouping. The most notable of which is in the bottom left corner and contain the necessary ground sink for all the powerful logic, memory and analog circuitry. Analog circuitry is grouped in the top right of the map while power rails can be found in the middle-left.

GPIO is arranged in six ports located throughout the ball-out. PORT B is on top, middle and bottom, PORT C is on the bottom, PORT D is on the left, PORT E is on top, PORT F is located at the top-middle and finally PORT G is on the middle-left and bottom of the ball out.



7. Mechanical and Packaging Information

The following diagram shows the package dimension of GR8 processor, includes the top, bottom, side views and details of the 14 mm x 14 mm package.





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